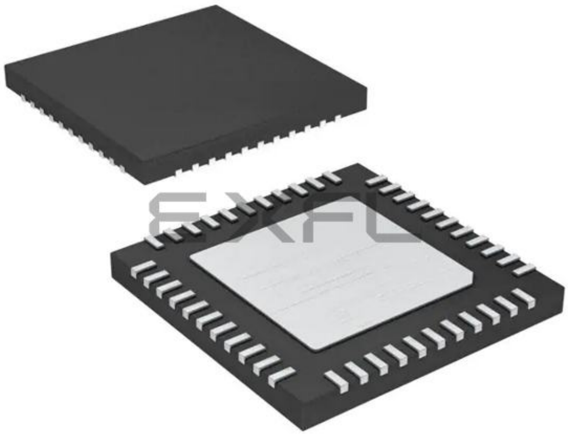


What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	I²C, LINbus, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	34
Program Memory Size	128KB (64K x 16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	3.8K x 8
Voltage - Supply (Vcc/Vdd)	2.15V ~ 3.6V
Data Converters	A/D 13x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-QFN (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f47j53-i-ml

TABLE 3-5: OSCILLATOR CONFIGURATION OPTIONS FOR USB OPERATION

Input Oscillator Frequency	PLL Division (PLLDIV<2:0>)	Clock Mode (FOSC<2:0>)	MCU Clock Division (CPDIV<1:0>)	Microcontroller Clock Frequency
48 MHz	N/A	EC	None (11)	48 MHz
			÷2 (10)	24 MHz
			÷3 (01)	16 MHz
			÷6 (00)	8 MHz
48 MHz	÷12 (000)	ECPLL	None (11)	48 MHz
			÷2 (10)	24 MHz
			÷3 (01)	16 MHz
			÷6 (00)	8 MHz
40 MHz	÷10 (001)	ECPLL	None (11)	48 MHz
			÷2 (10)	24 MHz
			÷3 (01)	16 MHz
			÷6 (00)	8 MHz
24 MHz	÷6 (010)	ECPLL	None (11)	48 MHz
			÷2 (10)	24 MHz
			÷3 (01)	16 MHz
			÷6 (00)	8 MHz
24 MHz	N/A	EC(1)	None (11)	24 MHz
			÷2 (10)	12 MHz
			÷3 (01)	8 MHz
			÷6 (00)	4 MHz
20 MHz	÷5 (011)	ECPLL	None (11)	48 MHz
			÷2 (10)	24 MHz
			÷3 (01)	16 MHz
			÷6 (00)	8 MHz
16 MHz	÷4 (100)	HSPLL, ECPLL	None (11)	48 MHz
			÷2 (10)	24 MHz
			÷3 (01)	16 MHz
			÷6 (00)	8 MHz
12 MHz	÷3 (101)	HSPLL, ECPLL	None (11)	48 MHz
			÷2 (10)	24 MHz
			÷3 (01)	16 MHz
			÷6 (00)	8 MHz
8 MHz	÷2 (110)	HSPLL, ECPLL, INTOSCPLL/ INTOSCPLLO	None (11)	48 MHz
			÷2 (10)	24 MHz
			÷3 (01)	16 MHz
			÷6 (00)	8 MHz
4 MHz	÷1 (111)	HSPLL, ECPLL	None (11)	48 MHz
			÷2 (10)	24 MHz
			÷3 (01)	16 MHz
			÷6 (00)	8 MHz

Note 1: The 24 MHz EC mode (without PLL) is only compatible with low-speed USB. Full-speed USB requires a 48 MHz system clock.

5.7 Reset State of Registers

Most registers are unaffected by a Reset. Their status is unknown on POR and unchanged by all other Resets. The other registers are forced to a “Reset state” depending on the type of Reset that occurred.

Most registers are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. Status bits from the RCON register ($\overline{\text{CM}}$, $\overline{\text{RI}}$, $\overline{\text{TO}}$, $\overline{\text{PD}}$, $\overline{\text{POR}}$ and $\overline{\text{BOR}}$) are set or cleared differently in different Reset situations, as indicated in Table 5-1. These bits are used in software to determine the nature of the Reset.

Table 5-2 describes the Reset states for all of the Special Function Registers. These are categorized by POR and BOR, $\overline{\text{MCLR}}$ and WDT Resets and WDT wake-ups.

TABLE 5-1: STATUS BITS, THEIR SIGNIFICANCE AND THE INITIALIZATION CONDITION FOR RCON REGISTER

Condition	Program Counter[1]	RCON Register						STKPTR Register	
		$\overline{\text{CM}}$	$\overline{\text{RI}}$	$\overline{\text{TO}}$	$\overline{\text{PD}}$	$\overline{\text{POR}}$	$\overline{\text{BOR}}$	STKFUL	STKUNF
Power-on Reset	0000h	1	1	1	1	0	0	0	0
RESET instruction	0000h	u	0	u	u	u	u	u	u
Brown-out Reset	0000h	1	1	1	1	u	0	u	u
Configuration Mismatch Reset	0000h	0	u	u	u	u	u	u	u
$\overline{\text{MCLR}}$ Reset during power-managed Run modes	0000h	u	u	1	u	u	u	u	u
$\overline{\text{MCLR}}$ Reset during power-managed Idle modes and Sleep mode	0000h	u	u	1	0	u	u	u	u
$\overline{\text{MCLR}}$ Reset during full-power execution	0000h	u	u	u	u	u	u	u	u
Stack Full Reset (STVREN = 1)	0000h	u	u	u	u	u	u	1	u
Stack Underflow Reset (STVREN = 1)	0000h	u	u	u	u	u	u	u	1
Stack Underflow Error (not an actual Reset, STVREN = 0)	0000h	u	u	u	u	u	u	u	1
WDT time-out during full-power or power-managed Run modes	0000h	u	u	0	u	u	u	u	u
WDT time-out during power-managed Idle or Sleep modes	PC + 2	u	u	0	0	u	u	u	u
Interrupt exit from power-managed modes	PC + 2	u	u	u	0	u	u	u	u

Legend: u = unchanged

Note 1: When the wake-up is due to an interrupt and the GIEH or GIEL bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

6.0 MEMORY ORGANIZATION

There are two types of memory in PIC18 Flash microcontrollers:

- Program Memory
- Data RAM

As Harvard architecture devices, the data and program memories use separate busses; this allows for concurrent access of the two memory spaces.

Section 7.0 "Flash Program Memory" provides additional information on the operation of the Flash program memory.

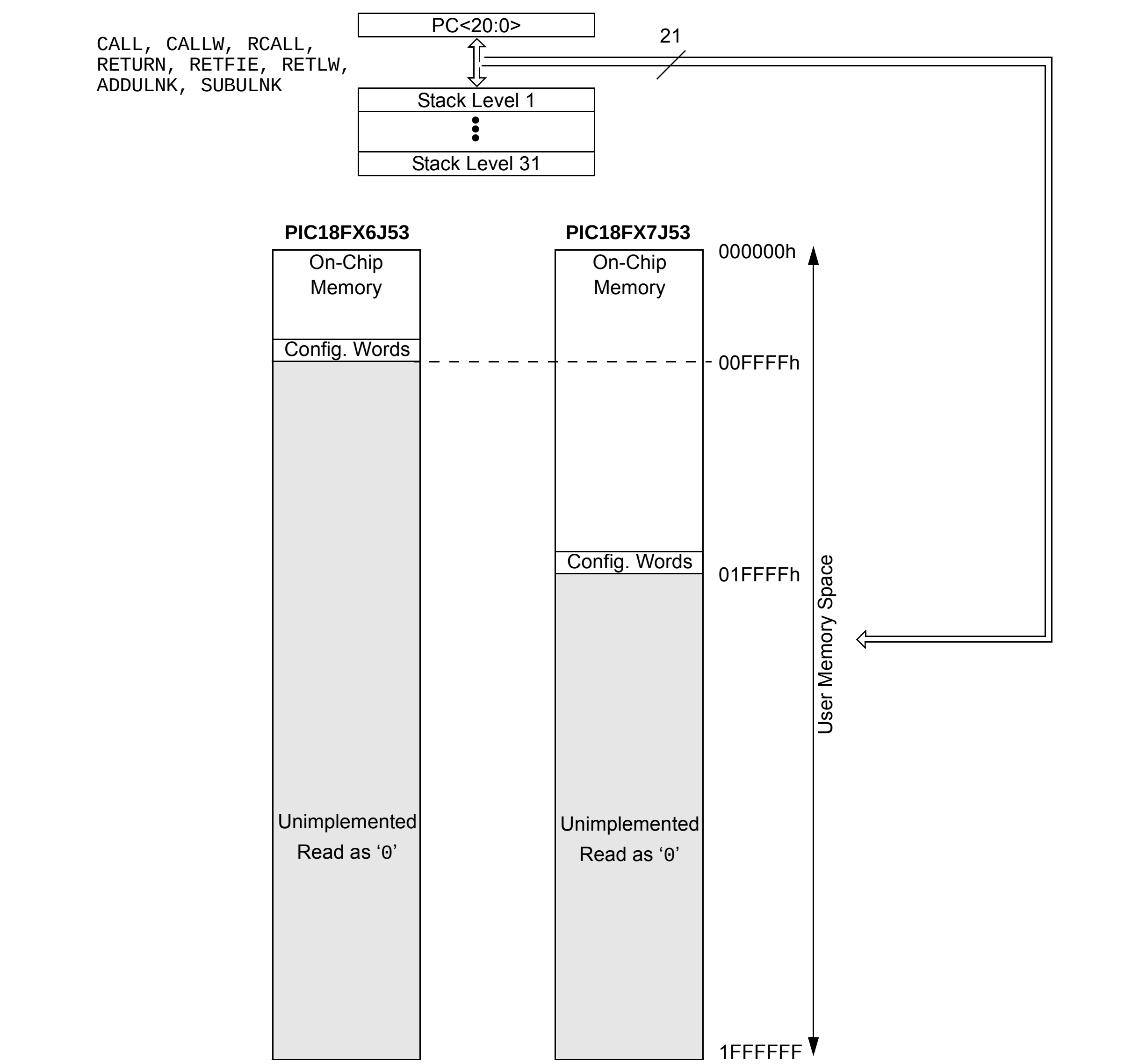
6.1 Program Memory Organization

PIC18 microcontrollers implement a 21-bit program counter, which is capable of addressing a 2-Mbyte program memory space. Accessing a location between the upper boundary of the physically implemented memory and the 2-Mbyte address returns all '0's (a NOP instruction).

The PIC18F47J53 family offers a range of on-chip Flash program memory sizes, from 64 Kbytes (up to 32,768 single-word instructions) to 128 Kbytes (65,536 single-word instructions).

Figure 6-1 provides the program memory maps for individual family devices.

FIGURE 6-1: MEMORY MAPS FOR PIC18F47J53 FAMILY DEVICES



Note: Sizes of memory areas are not to scale. Sizes of program memory areas are enhanced to show detail.

7.0 FLASH PROGRAM MEMORY

The Flash program memory is readable, writable and erasable during normal operation over the entire VDD range.

A read from program memory is executed on 1 byte at a time. A write to program memory is executed on blocks of 64 bytes at a time or 2 bytes at a time. Program memory is erased in blocks of 1024 bytes at a time. A bulk erase operation may not be issued from user code.

Writing or erasing program memory will cease instruction fetches until the operation is complete. The program memory cannot be accessed during the write or erase, therefore, code cannot execute. An internal programming timer terminates program memory writes and erases.

A value written to program memory does not need to be a valid instruction. Executing a program memory location that forms an invalid instruction results in a NOP.

7.1 Table Reads and Table Writes

In order to read and write program memory, there are two operations that allow the processor to move bytes between the program memory space and the data RAM:

- Table Read (TBLRD)
- Table Write (TBLWT)

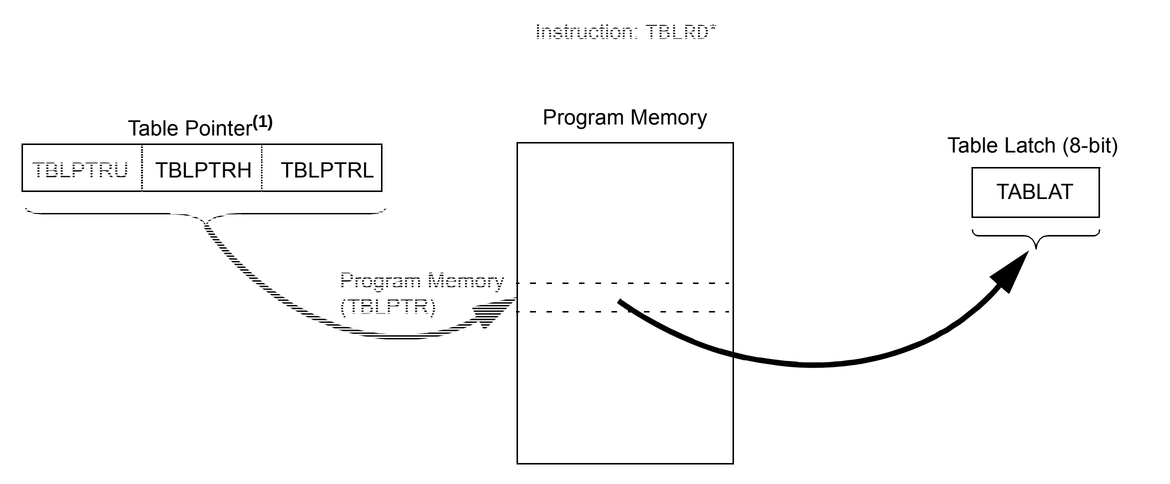
The program memory space is 16 bits wide, while the data RAM space is 8 bits wide. Table reads and table writes move data between these two memory spaces through an 8-bit register (TABLAT).

Table read operations retrieve data from program memory and place it into the data RAM space. Figure 7-1 illustrates the operation of a table read with program memory and data RAM.

Table write operations store data from the data memory space into holding registers in program memory. The procedure to write the contents of the holding registers into program memory is detailed in **Section 7.5 "Writing to Flash Program Memory"**. Figure 7-2 illustrates the operation of a table write with program memory and data RAM.

Table operations work with byte entities. A table block containing data, rather than program instructions, is not required to be word-aligned. Therefore, a table block can start and end at any byte address. If a table write is being used to write executable code into program memory, program instructions will need to be word-aligned.

FIGURE 7-1: TABLE READ OPERATION



Note 1: The Table Pointer register points to a byte in program memory.

9.6 INTx Pin Interrupts

External interrupts on the INT0, INT1, INT2 and INT3 pins are edge-triggered. If the corresponding INTEDGx bit in the INTCON2 register is set (= 1), the interrupt is triggered by a rising edge; if the bit is clear, the trigger is on the falling edge. When a valid edge appears on the INTx pin, the corresponding flag bit and INTxIF are set. This interrupt can be disabled by clearing the corresponding enable bit, INTxIE. Flag bit, INTxIF, must be cleared in software in the Interrupt Service Routine before re-enabling the interrupt.

All external interrupts (INT0, INT1, INT2 and INT3) can wake up the processor from the Sleep and Idle modes if bit, INTxIE, was set prior to going into the power-managed modes. Deep Sleep mode can wake up from INT0, but the processor will start execution from the power-on reset vector rather than branch to the interrupt vector.

Interrupt priority for INT1, INT2 and INT3 is determined by the value contained in the Interrupt Priority bits, INT1IP (INTCON3<6>), INT2IP (INTCON3<7>) and INT3IP (INTCON2<1>). There is no priority bit associated with INT0; It is always a high-priority interrupt source.

9.7 TMR0 Interrupt

In 8-bit mode (which is the default), an overflow in the TMR0 register (FFh $\rightarrow$ 00h) will set flag bit, TMR0IF. In 16-bit mode, an overflow in the TMR0H:TMR0L register pair (FFFFh $\rightarrow$ 0000h) will set TMR0IF. The interrupt can be enabled/disabled by setting/clearing enable bit, TMR0IE (INTCON<5>). Interrupt priority for Timer0 is determined by the value contained in the interrupt priority bit, TMR0IP (INTCON2<2>). See **Section 12.0 "Timer0 Module"** for further details on the Timer0 module.

9.8 PORTB Interrupt-on-Change

An input change on PORTB<7:4> sets flag bit, RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit, RBIE (INTCON<3>). Interrupt priority for PORTB interrupt-on-change is determined by the value contained in the interrupt priority bit, RBIP (INTCON2<0>).

9.9 Context Saving During Interrupts

During interrupts, the return PC address is saved on the stack. Additionally, the WREG, STATUS and BSR registers are saved on the Fast Return Stack. If a fast return from interrupt is not used (see **Section 6.3 "Data Memory Organization"**), the user may need to save the WREG, STATUS and BSR registers on entry to the Interrupt Service Routine. Depending on the user's application, other registers may also need to be saved. Example 9-1 saves and restores the WREG, STATUS and BSR registers during an Interrupt Service Routine.

EXAMPLE 9-1: SAVING STATUS, WREG AND BSR REGISTERS IN RAM

```
MOVWF   W_TEMP                  ; W_TEMP is in virtual bank
MOVFF   STATUS, STATUS_TEMP     ; STATUS_TEMP located anywhere
MOVFF   BSR, BSR_TEMP           ; BSR_TMEP located anywhere
;
; USER ISR CODE
;
MOVFF   BSR_TEMP, BSR           ; Restore BSR
MOVF    W_TEMP, W               ; Restore WREG
MOVFF   STATUS_TEMP, STATUS     ; Restore STATUS
```

10.7.6 PERIPHERAL PIN SELECT REGISTERS

The PIC18F47J53 family of devices implements a total of 37 registers for remappable peripheral configuration of 44-pin devices. The 28-pin devices have 31 registers for remappable peripheral configuration.

Note:	Input and output register values can only be changed if IOLOCK (PPSCON<0>) = 0. See Example 10-7 for a specific command sequence.

REGISTER 10-5: PPSCON: PERIPHERAL PIN SELECT INPUT REGISTER 0 (BANKED PPSCON)(1)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	IOLOCK
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-1 **Unimplemented:** Read as ‘0’

bit 0 **IOLOCK:** I/O Lock Enable bit
1 = I/O lock is active, RPORx and RPINRx registers are write-protected
0 = I/O lock is not active, pin configurations can be changed

Note 1: Register values can only be changed if IOLOCK (PPSCON<0>) = 0.

REGISTER 10-6: RPINR1: PERIPHERAL PIN SELECT INPUT REGISTER 1 (BANKED EE1h)

U-0	U-0	U-0	R/$\overline{W}$-1	R/$\overline{W}$-1	R/$\overline{W}$-1	R/$\overline{W}$-1	R/$\overline{W}$-1
—	—	—	INTR1R4	INTR1R3	INTR1R2	INTR1R1	INTR1R0
bit 7							bit 0

Legend:	R/$\overline{W}$ = Readable bit, Writable bit if IOLOCK = 0		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **INTR1R<4:0>:** Assign External Interrupt 1 (INT1) to the Corresponding RPn Pin bits

REGISTER 10-7: RPINR2: PERIPHERAL PIN SELECT INPUT REGISTER 2 (BANKED EE2h)

U-0	U-0	U-0	R/$\overline{W}$-1	R/$\overline{W}$-1	R/$\overline{W}$-1	R/$\overline{W}$-1	R/$\overline{W}$-1
—	—	—	INTR2R4	INTR2R3	INTR2R2	INTR2R1	INTR2R0
bit 7							bit 0

Legend:	R/$\overline{W}$ = Readable bit, Writable bit if IOLOCK = 0		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **INTR2R<4:0>:** Assign External Interrupt 2 (INT2) to the Corresponding RPn Pin bits

11.2.4 BUFFERED PARALLEL SLAVE PORT MODE

Buffered Parallel Slave Port mode is functionally identical to the legacy PSP mode with one exception, the implementation of 4-level read and write buffers. Buffered PSP mode is enabled by setting the INCM bits in the PMMODEH register. If the INCM<1:0> bits are set to '11', the PMP module will act as the buffered PSP.

When the Buffered PSP mode is active, the PMDIN1L, PMDIN1H, PMDIN2L and PMDIN2H registers become the write buffers and the PMDOUT1L, PMDOUT1H, PMDOUT2L and PMDOUT2H registers become the read buffers. Buffers are numbered, 0 through 3, starting with the lower byte of PMDIN1L to PMDIN2H as the read buffers and PMDOUT1L to PMDOUT2H as the write buffers.

11.2.4.1 READ FROM SLAVE PORT

For read operations, the bytes will be sent out sequentially, starting with Buffer 0 (PMDOUT1L<7:0>) and ending with Buffer 3 (PMDOUT2H<7:0>) for every read strobe. The module maintains an internal pointer to keep track of which buffer is to be read. Each buffer has a corresponding read status bit, OBxE, in the PMSTATL register. This bit is cleared when a buffer contains data that has not been written to the bus, and is set when data is written to the bus. If the current buffer location being read from is empty, a buffer underflow is generated and the Buffer Overflow Flag bit, OBUF, is set. If all four OBxE status bits are set, then the Output Buffer Empty flag (OBE) will also be set.

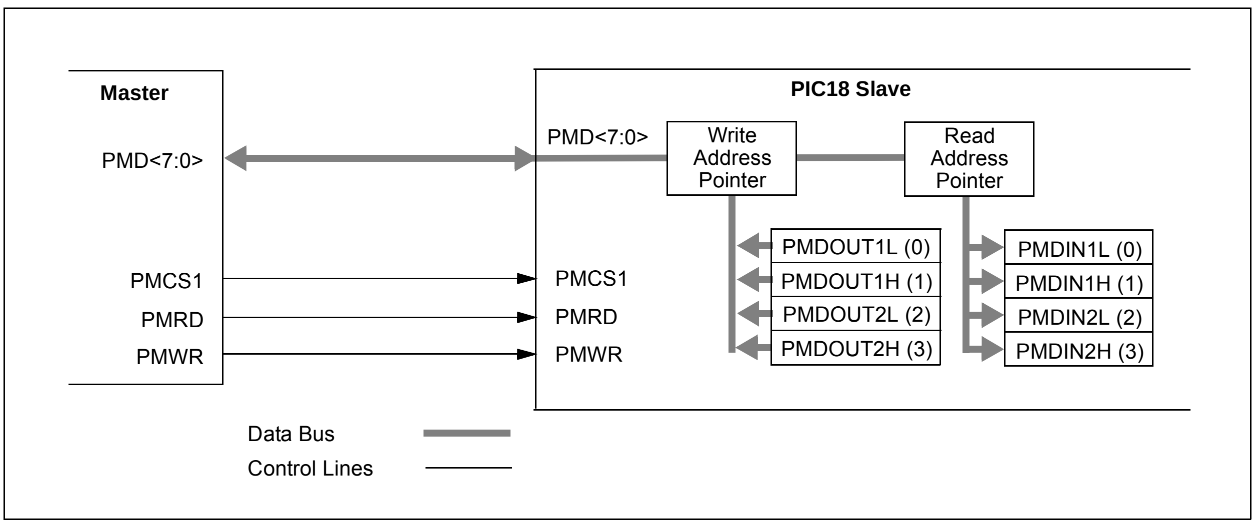
11.2.4.2 WRITE TO SLAVE PORT

For write operations, the data has to be stored sequentially, starting with Buffer 0 (PMDIN1L<7:0>) and ending with Buffer 3 (PMDIN2H<7:0>). As with read operations, the module maintains an internal pointer to the buffer that is to be written next.

The input buffers have their own write status bits: IBxF in the PMSTATH register. The bit is set when the buffer contains unread incoming data and cleared when the data has been read. The flag bit is set on the write strobe. If a write occurs on a buffer when its associated IBxF bit is set, the Buffer Overflow flag, IBOV, is set; any incoming data in the buffer will be lost. If all four IBxF flags are set, the Input Buffer Full Flag (IBF) is set.

In Buffered Slave mode, the module can be configured to generate an interrupt on every read or write strobe (IRQM<1:0> = 01). It can be configured to generate an interrupt on a read from Read Buffer 3 or a write to Write Buffer 3, which is essentially an interrupt every fourth read or write strobe (RQM<1:0> = 11). When interrupting every fourth byte for input data, all input buffer registers should be read to clear the IBxF flags. If these flags are not cleared, then there is a risk of hitting an overflow condition.

FIGURE 11-5: PARALLEL MASTER/SLAVE CONNECTION BUFFERED EXAMPLE



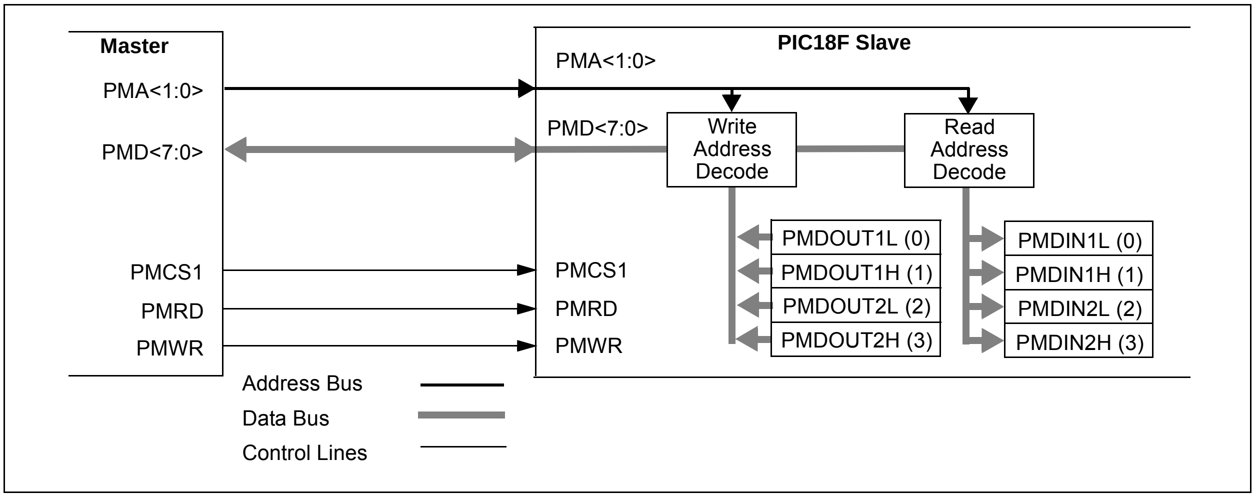
11.2.5 ADDRESSABLE PARALLEL SLAVE PORT MODE

In the Addressable Parallel Slave Port mode (PMMODEH<1:0> = `01`), the module is configured with two extra inputs, PMA<1:0>, which are the address lines 1 and 0. This makes the 4-byte buffer space directly addressable as fixed pairs of read and write buffers. As with Legacy Buffered mode, data is output from PMDOUT1L, PMDOUT1H, PMDOUT2L and PMDOUT2H, and is read in PMDIN1L, PMDIN1H, PMDIN2L and PMDIN2H. Table 11-1 provides the buffer addressing for the incoming address to the input and output registers.

TABLE 11-1: SLAVE MODE BUFFER ADDRESSING

PMA<1:0>	Output Register (Buffer)	Input Register (Buffer)
`00`	PMDOUT1L (0)	PMDIN1L (0)
`01`	PMDOUT1H (1)	PMDIN1H (1)
`10`	PMDOUT2L (2)	PMDIN2L (2)
`11`	PMDOUT2H((3)	PMDIN2H (3)

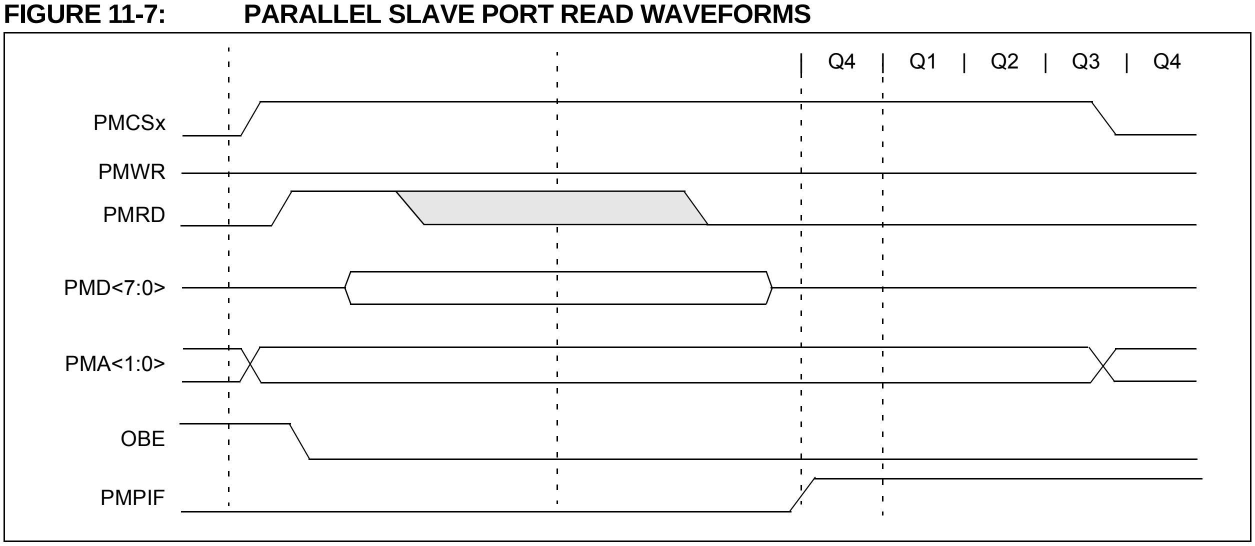
FIGURE 11-6: PARALLEL MASTER/SLAVE CONNECTION ADDRESSED BUFFER EXAMPLE



11.2.5.1 READ FROM SLAVE PORT

When chip select is active and a read strobe occurs (PMCSx = `1` and PMRD = `1`), the data from one of the four output bytes is presented onto PMD<7:0>. Which byte is read depends on the 2-bit address placed on ADDR<1:0>. Table 11-1 provides the corresponding output registers and their associated address. When an output buffer is read, the corresponding OBxE bit is set. The OBxE flag bit is set when all the buffers are empty. If any buffer is already empty, OBxE = `1`, the next read to that buffer will generate an OBUF event.

FIGURE 11-7: PARALLEL SLAVE PORT READ WAVEFORMS



REGISTER 18-2: CCPTMRS1: CCP4-10 TIMER SELECT 1 REGISTER (BANKED F51h)

R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
C7TSEL1	C7TSEL0	—	C6TSEL0	—	C5TSEL0	C4TSEL1	C4TSEL0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-6 **C7TSEL<1:0>:** CCP7 Timer Selection bit
- `00` = CCP7 is based off of TMR1/TMR2
- `01` = CCP7 is based off of TMR5/TMR4
- `10` = CCP7 is based off of TMR5/TMR6
- `11` = CCP7 is based off of TMR5/TMR8

bit 5 **Unimplemented:** Read as ‘0’

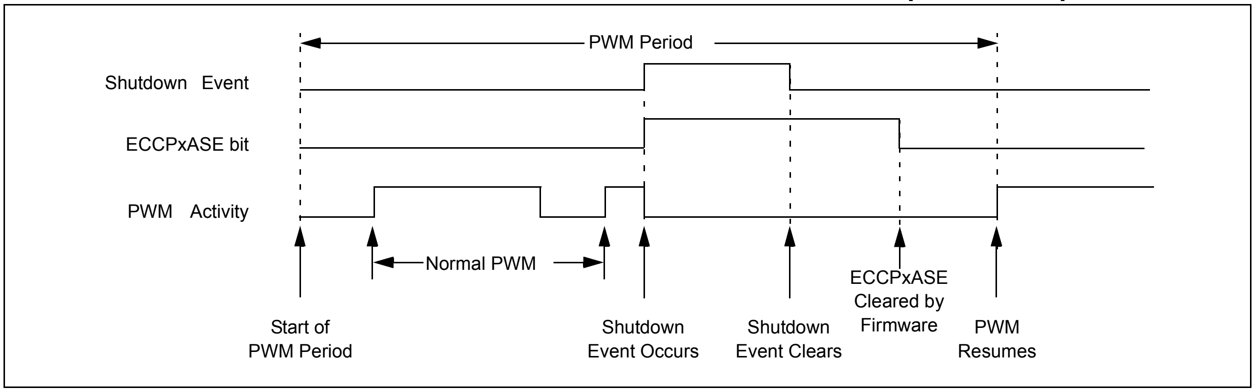
bit 4 **C6TSEL0:** CCP6 Timer Selection bit
- `0` = CCP6 is based off of TMR1/TMR2
- `1` = CCP6 is based off of TMR5/TMR2

bit 3 **Unimplemented:** Read as ‘0’

bit 2 **C5TSEL0:** CCP5 Timer Selection bit
- `0` = CCP5 is based off of TMR1/TMR2
- `1` = CCP5 is based off of TMR5/TMR4

bit 1-0 **C4TSEL<1:0>:** CCP4 Timer Selection bits
- `00` = CCP4 is based off of TMR1/TMR2
- `01` = CCP4 is based off of TMR3/TMR4
- `10` = CCP4 is based off of TMR3/TMR6
- `11` = Reserved; do not use

FIGURE 19-12: PWM AUTO-SHUTDOWN WITH FIRMWARE RESTART (PxRSEN = 0)



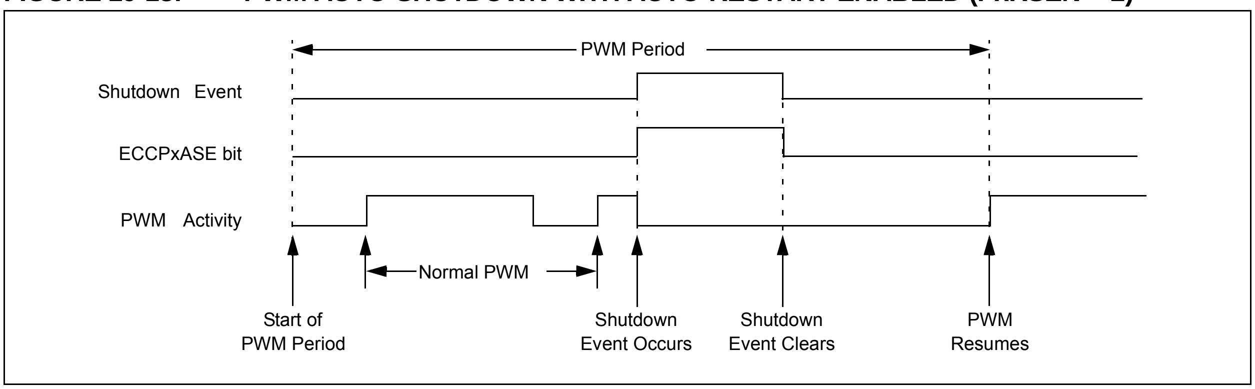
19.4.5 AUTO-RESTART MODE

The Enhanced PWM can be configured to automatically restart the PWM signal once the auto-shutdown condition has been removed. Auto-restart is enabled by setting the PxRSEN bit (ECCPxDEL<7>).

If auto-restart is enabled, the ECCPxASE bit will remain set as long as the auto-shutdown condition is active. When the auto-shutdown condition is removed, the ECCPxASE bit will be cleared via hardware and normal operation will resume.

The module will wait until the next PWM period begins, however, before re-enabling the output pin. This behavior allows the auto-shutdown with auto-restart features to be used in applications based on the current mode of PWM control.

FIGURE 19-13: PWM AUTO-SHUTDOWN WITH AUTO-RESTART ENABLED (PxRSEN = 1)



20.5.14 SLEEP OPERATION

While in Sleep mode, the I^{2}C module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from Sleep (if the MSSP interrupt is enabled).

20.5.15 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

20.5.16 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Start and Stop bits are cleared from a Reset or when the MSSP module is disabled. Control of the I^{2}C bus may be taken when the P bit (SSPxSTAT<4>) is set, or the bus is Idle, with both the Start and Stop bits clear. When the bus is busy, enabling the MSSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDAx line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed in hardware with the result placed in the BCLxIF bit.

The states where arbitration can be lost are:

- Address Transfer
- Data Transfer
- A Start Condition
- A Repeated Start Condition
- An Acknowledge Condition

20.5.17 MULTI -MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDAx pin, arbitration takes place when the master outputs a '1' on SDAx, by letting SDAx float high, and another master asserts a '0'. When the SCLx pin floats high, data should be stable. If the expected data on SDAx is a '1' and the data sampled on the SDAx pin = 0, then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCLxIF, and reset the I^{2}C port to its Idle state (Figure 20-27).

If a transmit was in progress when the bus collision occurred, the transmission is Halted, the BF flag is cleared, the SDAx and SCLx lines are deasserted and the SSPxBUF can be written to. When the user services the bus collision Interrupt Service Routine, and if the I^{2}C bus is free, the user can resume communication by asserting a Start condition.

If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDAx and SCLx lines are deasserted and the respective control bits in the SSPxCON2 register are cleared. When the user services the bus collision Interrupt Service Routine (ISR), and if the I^{2}C bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDAx and SCLx pins. If a Stop condition occurs, the SSPxIF bit will be set.

A write to the SSPxBUF will start the transmission of data at the first data bit regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the I^{2}C bus can be taken when the Stop bit is set in the SSPxSTAT register, or the bus is Idle and the Start and Stop bits are cleared.

FIGURE 20-27: BUS COLLISION TIMING FOR TRANSMIT AND ACKNOWLEDGE

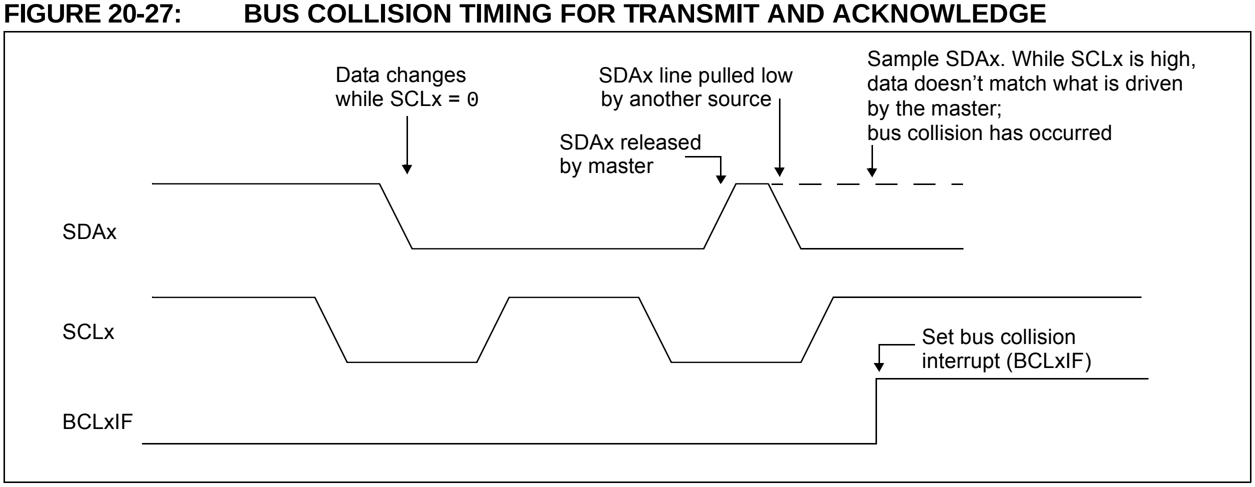
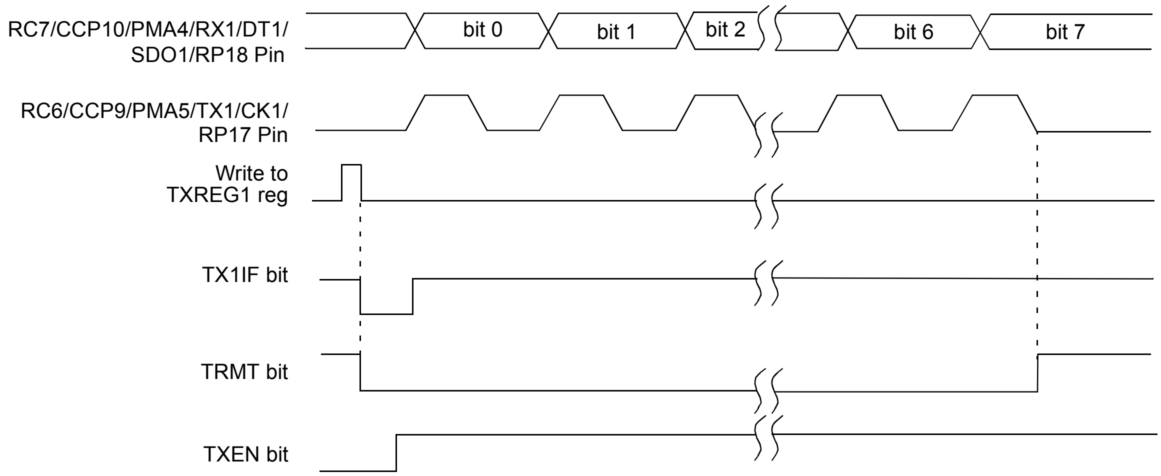


FIGURE 21-12: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)



Note: This example is equally applicable to EUSART2 (RPn1/TX2/CK2 and RPn2/RX2/DT2).

TABLE 21-7: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF
PIR1	PMPIF(1)	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF
PIE1	PMPIE(1)	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE
IPR1	PMPIP(1)	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CTMUIF	TMR3GIF	RTCCIF
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CTMUIE	TMR3GIE	RTCCIE
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CTMUIP	TMR3GIP	RTCCIP
RCSTAx	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
TXREGx	EUSARTx Transmit Register							
TXSTAx	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D
BAUDCONx	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN
SPBRGHx	EUSARTx Baud Rate Generator High Byte							
SPBRGx	EUSARTx Baud Rate Generator Low Byte							
ODCON2	—	—	—	—	CCP10OD	CCP9OD	U2OD	U1OD

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master transmission.

Note 1: These pins are only available on 44-pin devices.

21.3.2 EUSART SYNCHRONOUS MASTER RECEPTION

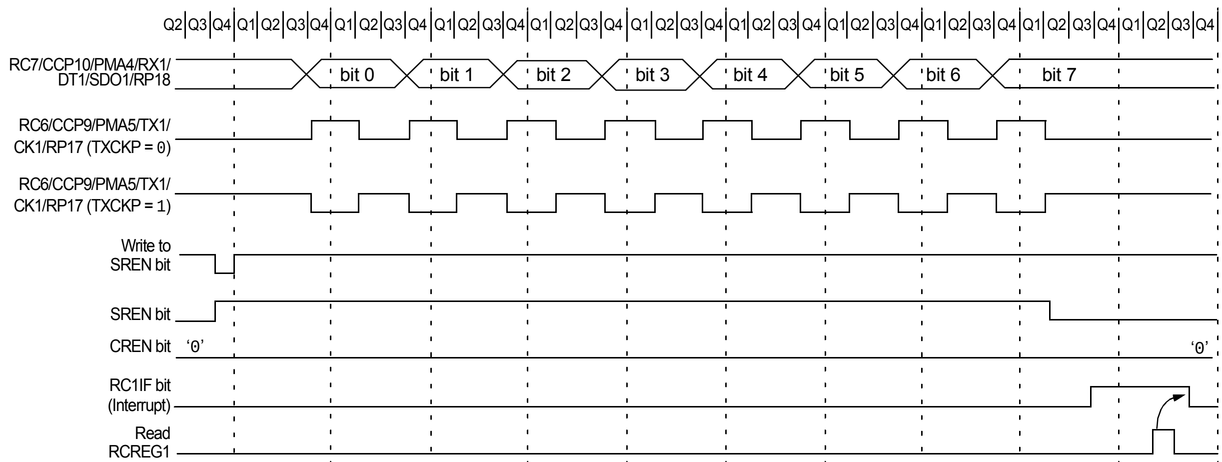
Once Synchronous mode is selected, reception is enabled by setting either the Single Receive Enable bit, SREN (RCSTAx<5>) or the Continuous Receive Enable bit, CREN (RCSTAx<4>). Data is sampled on the RXx pin on the falling edge of the clock.

If enable bit, SREN, is set, only a single word is received. If enable bit, CREN, is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

To set up a Synchronous Master Reception:

1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
2. Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.
3. Ensure bits, CREN and SREN, are clear.
4. If interrupts are desired, set enable bit, RCxIE.
5. If 9-bit reception is desired, set bit, RX9.
6. If a single reception is required, set bit, SREN. For continuous reception, set bit, CREN.
7. Interrupt flag bit, RCxIF, will be set when reception is complete and an interrupt will be generated if the enable bit, RCxIE, was set.
8. Read the RCSTAx register to get the ninth bit (if enabled) and determine if any error occurred during reception.
9. Read the 8-bit received data by reading the RCREGx register.
10. If any error occurred, clear the error by clearing bit, CREN.
11. If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 21-13: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)



Note: Timing diagram demonstrates Sync Master mode with bit, SREN = 1, and bit, BRGH = 0. This example is equally applicable to EUSART2 (RPn1/TX2/CK2 and RPn2/RX2/DT2).

TABLE 21-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF
PIR1	PMPIF(1)	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF
PIE1	PMPIE(1)	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE
IPR1	PMPIP(1)	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CTMUIF	TMR3GIF	RTCCIF
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CTMUIE	TMR3GIE	RTCCIE
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CTMUIP	TMR3GIP	RTCCIP
RCSTAx	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
RCREGx	EUSARTx Receive Register							
TXSTAx	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D
BAUDCONx	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN
SPBRGHx	EUSARTx Baud Rate Generator High Byte							
SPBRGx	EUSARTx Baud Rate Generator Low Byte							
ODCON2	—	—	—	—	CCP10OD	CCP9OD	U2OD	U1OD

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master reception.

Note 1: These pins are only available on 44-pin devices.

The ANCON0 and ANCON1 registers are used to configure the operation of the I/O pin associated with each analog channel. Setting any one of the PCFG bits configures the corresponding pin to operate as a digital only I/O. Clearing a bit configures the pin to operate as an analog input for either the A/D Converter or the comparator module. All digital peripherals are disabled and digital inputs read as '0'. As a rule, I/O pins that are multiplexed with analog inputs default to analog operation on device Resets.

In order to correctly perform A/D conversions on the V_{BG} band gap reference (ADCON0<5:2> = 1111), the reference circuit must be powered on first. The VBGEN bit in the ANCON1 register allows the firmware to manually request that the band gap reference circuit should be enabled. For best accuracy, firmware should allow a settling time of at least 10 ms prior to performing the first acquisition on this channel after enabling the band gap reference.

The reference circuit may already have been turned on if some other hardware module (such as the on-chip voltage regulator, comparators or HLVD) has already requested it. In this case, the initial turn-on settling time may have already elapsed and firmware does not need to wait as long before measuring V_{BG}. Once the acquisition is complete, firmware may clear the VBGEN bit, which will save a small amount of power if no other modules are still requesting the V_{BG} reference.

REGISTER 22-4: ANCON0: A/D PORT CONFIGURATION REGISTER 0 (BANKED F48h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PCFG7(1)	PCFG6(1)	PCFG5(1)	PCFG4	PCFG3	PCFG2	PCFG1	PCFG0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **PCFG<7:0>:** Analog Port Configuration bits (AN7-AN0)
1 = Pin configured as a digital port
0 = Pin configured as an analog channel – digital input disabled and reads '0'

Note 1: These bits are only available only on 44-pin devices.

REGISTER 22-5: ANCON1: A/D PORT CONFIGURATION REGISTER 1 (BANKED F49h)

R/W-0	R	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
VBGEN	r	—	PCFG12	PCFG11	PCFG10	PCFG9	PCFG8
bit 7							bit 0

Legend:	r = Reserved bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **VBGEN:** 1.2V Band Gap Reference Enable bit
1 = 1.2V band gap reference is powered on
0 = 1.2V band gap reference is turned off to save power (if no other modules are requesting it)

bit 6 **Reserved:** Always maintain as '0' for lowest power consumption

bit 5 **Unimplemented:** Read as '0'

bit 4-0 **PCFG<12:8>:** Analog Port Configuration bits (AN12-AN8)
1 = Pin configured as a digital port
0 = Pin configured as an analog channel – digital input disabled and reads '0'

REGISTER 28-1: CONFIG1L: CONFIGURATION REGISTER 1 LOW (BYTE ADDRESS 300000h)

R/WO-1	R/WO-1	R/WO-1	R/WO-1	R/WO-1	R/WO-1	R/WO-1	R/WO-1
$\overline{\text{DEBUG}}$	XINST	STVREN	$\overline{\text{CFGPLLEN}}$	PLLDIV2	PLLDIV1	PLLDIV0	WDTEN
bit 7							bit 0

Legend:			
R = Readable bit	WO = Write-Once bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **$\overline{\text{DEBUG}}$:** Background Debugger Enable bit

1 = Background debugger is disabled; RB6 and RB7 configured as general purpose I/O pins
0 = Background debugger is enabled; RB6 and RB7 are dedicated to In-Circuit Debug

bit 6 **XINST:** Extended Instruction Set Enable bit

1 = Instruction set extension and Indexed Addressing mode are enabled
0 = Instruction set extension and Indexed Addressing mode are disabled

bit 5 **STVREN**: Stack Overflow/Underflow Reset Enable bit

1 = Reset on stack overflow/underflow is enabled
0 = Reset on stack overflow/underflow is disabled

bit 4 **$\overline{\text{CFGPLLEN}}$:** PLL Enable bit

1 = 96 MHz PLL is disabled
0 = 96 MHz PLL is enabled

bit 3-1 **PLLDIV<2:0>:** Oscillator Selection bits

Divider must be selected to provide a 4 MHz input into the 96 MHz PLL.
111 = No divide – oscillator used directly (4 MHz input)
110 = Oscillator divided by 2 (8 MHz input)
101 = Oscillator divided by 3 (12 MHz input)
100 = Oscillator divided by 4 (16 MHz input)
011 = Oscillator divided by 5 (20 MHz input)
010 = Oscillator divided by 6 (24 MHz input)
001 = Oscillator divided by 10 (40 MHz input)
000 = Oscillator divided by 12 (48 MHz input)

bit 0 **WDTEN:** Watchdog Timer Enable bit

1 = WDT is enabled
0 = WDT is disabled (control is placed on the SWDTEN bit)

MULLW **Multiply Literal with W**

Syntax:	MULLW k
Operands:	$0 \leq k \leq 255$
Operation:	(W) x k → PRODH:PRODL
Status Affected:	None
Encoding:	`0000` `1101` `kkkk` `kkkk`
Description:	An unsigned multiplication is carried out between the contents of W and the 8-bit literal 'k'. The 16-bit result is placed in the PRODH:PRODL register pair. PRODH contains the high byte. W is unchanged. None of the Status flags are affected. Note that neither Overflow nor Carry is possible in this operation. A Zero result is possible but not detected.
Words:	1
Cycles:	1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write registers PRODH: PRODL

Example: `MULLW 0C4h`

Before Instruction
W = E2h
PRODH = ?
PRODL = ?
After Instruction
W = E2h
PRODH = ADh
PRODL = 08h

MULWF **Multiply W with f**

Syntax:	MULWF f {,a}
Operands:	$0 \leq f \leq 255$ $a \in [0,1]$
Operation:	(W) x (f) → PRODH:PRODL
Status Affected:	None
Encoding:	`0000` `001a` `ffff` `ffff`
Description:	An unsigned multiplication is carried out between the contents of W and the register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both W and 'f' are unchanged. None of the Status flags are affected. Note that neither Overflow nor Carry is possible in this operation. A Zero result is possible but not detected. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \leq 95$ (5Fh). See **Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.
Words:	1
Cycles:	1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write registers PRODH: PRODL

Example: `MULWF REG, 1`

Before Instruction
W = C4h
REG = B5h
PRODH = ?
PRODL = ?
After Instruction
W = C4h
REG = B5h
PRODH = 8Ah
PRODL = 94h

29.2.3 BYTE-ORIENTED AND BIT-ORIENTED INSTRUCTIONS IN INDEXED LITERAL OFFSET MODE

Note:	Enabling the PIC18 instruction set extension may cause legacy applications to behave erratically or fail entirely.

In addition to eight new commands in the extended set, enabling the extended instruction set also enables Indexed Literal Offset Addressing (**Section 6.6.1 "Indexed Addressing with Literal Offset"**). This has a significant impact on the way that many commands of the standard PIC18 instruction set are interpreted.

When the extended set is disabled, addresses embedded in opcodes are treated as literal memory locations: either as a location in the Access Bank (a = `0`) or in a GPR bank designated by the BSR (a = `1`). When the extended instruction set is enabled and a = `0`, however, a file register argument of 5Fh or less is interpreted as an offset from the pointer value in FSR2 and not as a literal address. For practical purposes, this means that all instructions that use the Access RAM bit as an argument – that is, all byte-oriented and bit-oriented instructions, or almost half of the core PIC18 instructions – may behave differently when the extended instruction set is enabled.

When the content of FSR2 is 00h, the boundaries of the Access RAM are essentially remapped to their original values. This may be useful in creating backward-compatible code. If this technique is used, it may be necessary to save the value of FSR2 and restore it when moving back and forth between C and assembly routines in order to preserve the Stack Pointer. Users must also keep in mind the syntax requirements of the extended instruction set (see **Section 29.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands"**).

Although the Indexed Literal Offset mode can be very useful for dynamic stack and pointer manipulation, it can also be very annoying if a simple arithmetic operation is carried out on the wrong register. Users who are accustomed to the PIC18 programming must keep in mind that, when the extended instruction set is enabled, register addresses of 5Fh or less are used for Indexed Literal Offset Addressing.

Representative examples of typical byte-oriented and bit-oriented instructions in the Indexed Literal Offset mode are provided on the following page to show how execution is affected. The operand conditions shown in the examples are applicable to all instructions of these types.

29.2.3.1 Extended Instruction Syntax with Standard PIC18 Commands

When the extended instruction set is enabled, the file register argument 'f' in the standard byte-oriented and bit-oriented commands is replaced with the literal offset value 'k'. As already noted, this occurs only when 'f' is less than or equal to 5Fh. When an offset value is used, it must be indicated by square brackets ("[ ]"). As with the extended instructions, the use of brackets indicates to the compiler that the value is to be interpreted as an index or an offset. Omitting the brackets, or using a value greater than 5Fh within the brackets, will generate an error in the MPASM Assembler.

If the index argument is properly bracketed for Indexed Literal Offset Addressing, the Access RAM argument is never specified; it will automatically be assumed to be '`0`'. This is in contrast to standard operation (extended instruction set disabled), when 'a' is set on the basis of the target address. Declaring the Access RAM bit in this mode will also generate an error in the MPASM Assembler.

The destination argument 'd' functions as before.

In the latest versions of the MPASM Assembler, language support for the extended instruction set must be explicitly invoked. This is done with either the command line option, `/y`, or the PE directive in the source listing.

29.2.4 CONSIDERATIONS WHEN ENABLING THE EXTENDED INSTRUCTION SET

It is important to note that the extensions to the instruction set may not be beneficial to all users. In particular, users who are not writing code that uses a software stack may not benefit from using the extensions to the instruction set.

Additionally, the Indexed Literal Offset Addressing mode may create issues with legacy applications written to the PIC18 assembler. This is because instructions in the legacy code may attempt to address registers in the Access Bank below 5Fh. Since these addresses are interpreted as literal offsets to FSR2 when the instruction set extension is enabled, the application may read or write to the wrong data addresses.

When porting an application to the PIC18F47J53 family, it is very important to consider the type of code. A large, re-entrant application that is written in C and would benefit from efficient compilation will do well when using the instruction set extensions. Legacy applications that heavily use the Access Bank will most likely not benefit from using the extended instruction set.

31.1 DC Characteristics: Supply Voltage PIC18F47J53 Family (Industrial)

PIC18F47J53 Family			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial				
Param. No.	**Symbol**	**Characteristic**	**Min.**	**Typ.**	**Max.**	**Units**	**Conditions**
D001	VDD	Supply Voltage	2.15	—	3.6	V	PIC18F4XJ53, PIC18F2XJ53
D001A	VDD	Supply Voltage	2.0	—	3.6	V	PIC18LF4XJ53, PIC18LF2XJ53
D001B	VDDCORE	External Supply for Microcontroller Core	2.0	—	2.75	V	PIC18LF4XJ53, PIC18LF2XJ53
D001C	AVDD	Analog Supply Voltage	VDD – 0.3	—	VDD + 0.3	V	
D001D	AVSS	Analog Ground Potential	VSS – 0.3	—	VSS + 0.3	V	
D001E	VUSB	USB Supply Voltage	3.0	3.3	3.6	V	USB module enabled(2)
D002	VDR	RAM Data Retention Voltage(1)	1.5	—	—	V	
D003	VPOR	VDD Start Voltage to Ensure Internal Power-on Reset Signal	—	—	0.7	V	See **Section 5.3 “Power-on Reset (POR)”** for details
D004	SVDD	VDD Rise Rate to Ensure Internal Power-on Reset Signal	0.05	—	—	V/ms	See **Section 5.3 “Power-on Reset (POR)”** for details
D005	VBOR	VDDCORE Brown-out Reset Voltage	—	2.0	—	V	PIC18F4XJ53, PIC18F2XJ53 only
D006	VDSBOR	VDD Brown-out Reset Voltage	—	1.8	—	V	DSBOREN = 1 on “LF” device or “F” device in Deep Sleep

Note 1: This is the limit to which VDDCORE can be lowered in Sleep mode, or during a device Reset, without losing RAM data.

2: VUSB should always be maintained ≥ VDD, but may be left floating when the USB module is disabled and RC4/RC5 will not be used as general purpose inputs.

31.2 DC Characteristics: Power-Down and Supply Current PIC18F47J53 Family (Industrial) (Continued)

PIC18LF47J53 Family		**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ T_A ≤ +85°C for industrial					
PIC18F47J53 Family		**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ T_A ≤ +85°C for industrial					
Param. No.	**Device**	**Typ.**	**Max.**	**Units**	**Conditions**		
D025 (ΔI_{OSCB})	**Module Differential Currents (ΔI_{WDT}, ΔI_{HLVD}, ΔI_{OSCB}, ΔI_{AD}, ΔI_{USB})**						
	Real-Time Clock/Calendar with Low-Power Timer1 Oscillator	0.5	4.0	μA	-40°C	V_{DD} = 2.15V, V_{DDCORE} = 10 μF Capacitor	PIC18FXXJ53 32.768 kHz[3], T1OSCEN = 1, (SOSCSEL<1:0> = 01)
		0.7	4.5	μA	+25°C		
		0.8	4.5	μA	+60°C		
		0.9	4.5	μA	+85°C		
		0.6	4.5	μA	-40°C	V_{DD} = 2.5V, V_{DDCORE} = 10 μF Capacitor	
		0.8	5.0	μA	+25°C		
		0.9	5.0	μA	+60°C		
		1.0	5.0	μA	+85°C		
		0.8	6.5	μA	-40°C	V_{DD} = 3.3V, V_{DDCORE} = 10 μF Capacitor	
		1.0	6.5	μA	+25°C		
		1.1	8.0	μA	+60°C		
		1.3	8.0	μA	+85°C		

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to V_{DD} or V_{SS} and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption. All features that add delta current are disabled (USB module, WDT, etc.). The test conditions for all I_{DD} measurements in active operation mode are:
OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to V_{DD}/V_{SS};
$\overline{MCLR}$ = V_{DD}; WDT disabled unless otherwise specified.

3: Low-power Timer1 with standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

4: This is the module differential current when the USB module is enabled and clocked at 48 MHz, but with no USB cable attached. When the USB cable is attached or data is being transmitted, the current consumption may be much higher (see **Section 23.6.4 "USB Transceiver Current Consumption"**). During USB Suspend mode (USBEN = 1, SUSPND = 1, bus in Idle state), the USB module current will be dominated by the D+ or D- pull-up resistor. The integrated pull-up resistors use "resistor switching" according to the `resistor_ecn` supplement to the USB 2.0 Specifications, and therefore, may be as low as 900Ω during Idle conditions.

